

### 16-Channel PWM Constant Current LED Driver for 1:32 Time-Multiplexing Applications

#### **Features**

- 3V-5.5V supply voltage
- 16 constant current output channels
- Constant output current range:
  - 0.5~20mA @ 5V supply voltage - 0.5~10mA @ 3.3V supply voltage
- Excellent output current accuracy: Between channels:: <±2.5% (Max.) Between ICs: <±3%(Max.)
- Built-in 16K-bit SRAM to support time-multiplexing for 1 ~ 32 scans
- 14-bit /13-bit color depth PWM control to improve visual refresh rate
- 6bit current gain, 12.5%~200%
- LED failure isolation -LED failure induced cross elimination
- LED open detection
- Integrating ghost elimination circuit
- GCLK multiplier technology
- Maximum DCLK frequency: 30MHz

# Shrink SOP GP: SSOP24L-150-0.64 **Quad Flat No-leads** GFN: QFN24L-4x4-0.5

#### **Product Description**

MBI5153 is designed for LED video applications using internal Pulse Width Modulation (PWM) control with selectable 14-bit / 13-bit color depth. MBI5153 features a 16-bit shift register which converts serial input data into each pixel's gray scale of the output port. Sixteen regulated current ports are designed to provide uniform and constant current sinks for driving LEDs with a wide range of V<sub>F</sub> variations. The output current can be preset through an external resistor. The innovative architecture with embedded SRAM is designed to support up to 1:32 time-multiplexing applications. Users only need to send the whole frame data once and to store in the embedded SRAM of the LED driver, instead of sending every time when the scan line is changed. It helps to save the data bandwidth and to achieve high grayscale with very low data clock rate. With scan-type Scrambled-PWM (S-PWM) technology, MBI5153 enhances PWM by scrambling the "on" time of each scan line into several "on" periods and sequentially drives each scan line for a short "on" period. The enhancement equivalently increases the visual refresh rate of scan-type LED displays. In addition, the innovative GCLK multiplier technique doubles visual refresh rate.

MBI5153 drives the corresponding LEDs to the brightness specified by image data. With MBI5153, all output channels can be built with 14-bit color depth (16,384 gray scales). When building a 14-bit color depth video, S-PWM technology reduces the flickers and improves the image fidelity.

Through compulsory error detection, MBI5153 detects individual LED for open-circuit errors without extra components. MBI5153 equipped an innovative cross elimination function, and it solves the cross phenomenon induced by failure LEDs. Besides, integrated ghost elimination circuit eases the ghost problems.

#### **Block Diagram**

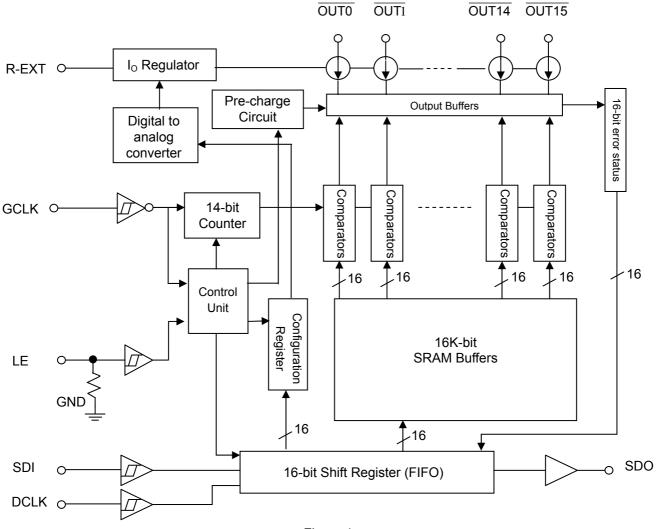
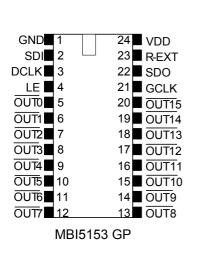
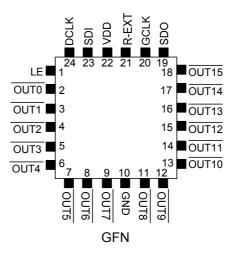


Figure 1



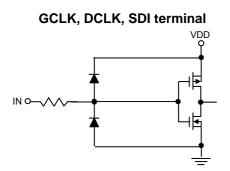
**Pin Configuration** 

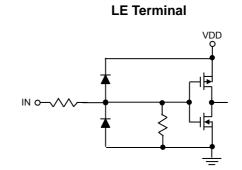


#### **Terminal Description**

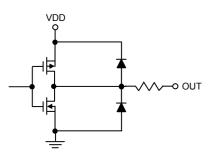
Pin Name	Function
GND	Ground terminal for control logic and current sink
SDI	Serial-data input to the shift register
DCLK	Clock input terminal used to shift data on rising edge and carries command information when LE is asserted.
LE	Data strobe terminal and controlling command with DCLK
OUT0 ~ OUT15	Constant current output terminals
GCLK	Gray scale clock terminal Clock input for gray scale. The gray scale display is counted by gray scale clock compared with input data.
SDO	Serial-data output to the receiver-end SDI of next LED driver
R-EXT	Input terminal used to connect an external resistor for setting up output current for all output channels
VDD	3.3V/5V supply voltage terminal

### **Equivalent Circuits of Inputs and Outputs**





**SDO Terminal** 



#### **Maximum Rating**

Charact	eristic	Symbol	Rating	Unit
Supply Voltage		V <sub>DD</sub>	0~7	V
Input Pin Voltage (SDI, DCL	K, GCLK, LE)	V <sub>IN</sub>	-0.4~V <sub>DD</sub> +0.4	V
Sustaining Voltage at OUT	Port	V <sub>DS</sub>	-0.5~17	V
Output Current		I <sub>OUT</sub>	+22	mA
GND Terminal Current		I <sub>GND</sub>	360	mA
Power Dissipation	GP Type	5	1.79	
(On 4 Layer PCB, Ta=25°C	)* GFN Type	P <sub>D</sub>	3.12	W
Thermal Resistance	GP Type		69.5	°0444
(On 4 Layer PCB, Ta=25°C	)* GFN Type	R <sub>th(j-a)</sub>	40.01	°C/W
Junction Temperature		T <sub>j</sub> , <sub>max</sub>	150**	°C
Operating Ambient Temperation	ature	T <sub>opr</sub>	-40~+85	°C
Storage Temperature		T <sub>stg</sub>	-55~+150	°C
	HBM (MIL-STD-883G Method 3015.7, Human 3ody Mode)	НВМ	Class 3B (8000V)	-
ESD Rating	MM (JEDEĆ EIA/JESD22-A115, Machine Mode)	ММ	Class C (≧400V)	-

\*The PCB size is 76.2mm\*114.3mm in simulation. Please refer to JEDEC JESD51.

\*\* Operation at the maximum rating for extended periods may reduce the device reliability; therefore, the suggested junction temperature of the device is under 125°C.

Note: The performance of thermal dissipation is strongly related to the size of thermal pad, thickness and layer numbers of the PCB. The empirical thermal resistance may be different from simulative value. User should plan for expected thermal dissipation performance by selecting package and arranging layout of the PCB to maximize the capability.

for 1:32 Time-multiplexing Applications

### Electrical Characteristics (V<sub>DD</sub>=5.0V, Ta=25°C)

C	haracteris	tics	Symbol	C	ondi	tion	Min.	Тур.	Max.	Unit
Supply Vo	oltage		V <sub>DD</sub>	-			4.5	5.0	5.5	V
Sustaining Voltage at OUT Ports			V <sub>DS</sub>	OUT0 ~ OUT15			-	-	17.0	V
			I <sub>OUT</sub>	Refer to "Test Circuit for Electrical Characteristics"		uit for Electrical	0.5	-	20	mA
Output Cu	urrent		I <sub>OH</sub>	SDO			-	-	-1.0	mA
			I <sub>OL</sub>	SDO			-	-	1.0	mA
		"H" level	V <sub>IH</sub>	Ta=-40~85°C			$0.7 \mathrm{xV}_{\mathrm{DD}}$	-	V <sub>DD</sub>	V
Input Volt	age	"L" level	V <sub>IL</sub>	Ta=-40~85°C			GND	-	$0.3 x V_{DD}$	V
Output Le	akage Curr	ent	I <sub>OH</sub>	V <sub>DS</sub> =17.0V			-	-	0.5	μA
Output Voltage SDO		000	V <sub>он</sub>	I <sub>OH</sub> =-1.0mA			V <sub>DD</sub> -0.4	-	-	V
		V <sub>OL</sub>	I <sub>OL</sub> =+1.0mA		-	-	0.4	V		
Current Skew (Channel)		dl <sub>out1</sub>	I <sub>OUT</sub> =1mA V <sub>DS</sub> =1.0V		R <sub>ext</sub> =14kΩ	-	±1.5	±2.5	%	
Current S	kew (IC)		dl <sub>OUT2</sub>	I <sub>OUT</sub> =1mA V <sub>DS</sub> =1.0V		R <sub>ext</sub> =14kΩ	-	±1.5	±3.0	%
Output Cu Output Vo	urrent vs. oltage Regu	lation*	%/dV <sub>DS</sub>	$V_{DS}$ within 1.0V and 3.0V, R <sub>ext</sub> =1.4K $\Omega$ @10mA		-	±0.1	±0.3	% / V	
Output Cu Supply Vo	urrent vs. oltage Regu	lation*	%/dV <sub>DD</sub>	V <sub>DD</sub> within 4.5 R <sub>ext</sub> =1.4KΩ@			-	±1.0	±2.0	% / V
LED Ope	n Detection	Threshold	V <sub>OD,TH</sub>	-			-	0.5	-	V
Pull-down	Resistor		R <sub>IN</sub> (down)	LE			250	450	800	KΩ
	"	)ff"	I <sub>DD</sub> (off) 1	R <sub>ext</sub> =Open,	OUT		-	4.5	5.5	
	(SDI=DC	LK=GCLK	I <sub>DD</sub> (off) 3	R <sub>ext</sub> =14KΩ,	OUT	0~ 0UT15 =Off	-	5	6	
Supply Current		=0Hz)		R <sub>ext</sub> =1.4KΩ, OUT0~OUT15=Off			-	6.5	8	mA
	-	)n" LK=5MHz,	I <sub>DD</sub> (on) 9	R <sub>ext</sub> =14KΩ,	$R_{ext}=14K\Omega, \overline{OUT0}\sim\overline{OUT15}=On$			6.5	8	
		20MHz)	I <sub>DD</sub> (on) 10	R <sub>ext</sub> =1.4KΩ,	TUO		-	8.5	10	

\*One channel on.

for 1:32 Time-multiplexing Applications

### Electrical Characteristics (V<sub>DD</sub>=3.3V, Ta=25°C)

	Characteris	stics	Symbol	Con	dition	Min.	Тур.	Max.	Unit
Supply \	Voltage		V <sub>DD</sub>		-	3.0	3.3	3.6	V
Sustaining Voltage at OUT Ports			V <sub>DS</sub>	OUT0 ~ OUT15	-	-	17.0	V	
			I <sub>OUT</sub>	Refer to "Test Circ Characteristics"	uit for Electrical	0.5	-	10	mA
Output (	Current		I <sub>ОН</sub>	SDO		-	-	-1.0	mA
			I <sub>OL</sub>	SDO		-	-	1.0	mA
	140.00	"H" level	V <sub>IH</sub>	Ta=-40~85°C		$0.7 \mathrm{xV}_{\mathrm{DD}}$	-	V <sub>DD</sub>	V
Input Vo	oitage	"L" level	V <sub>IL</sub>	Ta=-40~85°C		GND	-	$0.3 x V_{DD}$	V
Output I	_eakage Cur	rent	I <sub>он</sub>	V <sub>DS</sub> =17.0V		-	-	0.5	μA
0.11)	( - 11	000	V <sub>OH</sub>	I <sub>OH</sub> =-1.0mA		V <sub>DD</sub> -0.4	-	-	V
Output Voltage SDO		V <sub>OL</sub>	I <sub>OL</sub> =+1.0mA	-	-	0.4	V		
Current Skew (Channel)			dl <sub>out1</sub>	I <sub>OUT</sub> =1mA V <sub>DS</sub> =1.0V	R <sub>ext</sub> =14kΩ	-	±1.5	±2.5	%
Current	Skew (IC)		dl <sub>out2</sub>	I <sub>OUT</sub> =1mA V <sub>DS</sub> =1.0V	R <sub>ext</sub> =14kΩ	-	±1.5	±3.0	%
Output \	Current vs. Voltage Regi	ulation*	%/dV <sub>DS</sub>	V <sub>DS</sub> within 1.0V an R <sub>ext</sub> =1.4KΩ@10m/	-	±0.1	±0.3	% / V	
	Current vs. Voltage Reg	ulation*	%/dV <sub>DD</sub>	V <sub>DD</sub> within 3.0V an R <sub>ext</sub> =1.4KΩ@10m/	-	±1.0	±2.0	% / V	
LED Op	en Detectior	n Threshold	V <sub>OD,TH</sub>	-		-	0.3	-	V
Pull-dov	vn Resistor		R <sub>IN</sub> (down)	LE		250	450	800	KΩ
			I <sub>DD</sub> (off) 1	R <sub>ext</sub> =Open, OUT	)~ OUT15=Off	-	4.5	5	
		Off" =GCLK=0Hz)	I <sub>DD</sub> (off) 2	R <sub>ext</sub> =14KΩ, OUT	0~ OUT15=Off	-	4.5	5.5	
Supply Current	,		I <sub>DD</sub> (off) 3	R <sub>ext</sub> =1.4KΩ, OUT0~OUT15=Off		-	6.0	7.0	mA
		Dn" ℃LK=5MHz,	I <sub>DD</sub> (on) 2	R <sub>ext</sub> =14KΩ, OUT	0~ OUT15=On	-	6.0	7.0	
		=20MHz)	I <sub>DD</sub> (on) 3	R <sub>ext</sub> =1.4KΩ, OUT	0~ OUT15=On	-	7.5	9.0	

\*One channel on.

#### **Test Circuit for Electrical Characteristics**

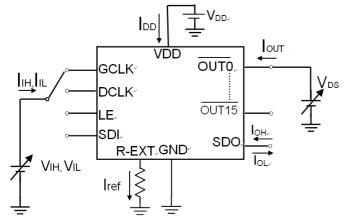


Figure 2

for 1:32 T	ime-multiplexing Applications							
Switching Characteristics ( $V_{DD}$ =5.0V, Ta=25°C)								

Characteristics		Symbol	Condition	Min.	Тур.	Max.	Unit
	SDI - DCLK ↑	t <sub>suo</sub>		5	-	-	ns
Catur Time	LE↑ – DCLK↑	t <sub>su1</sub>		8	-	-	ns
Setup Time	$LE\downarrow(Vsync)-GCLK$	t <sub>SU2</sub>		1200			ns
	$LE\downarrow\ -DCLK\uparrow$	t <sub>su3</sub>		50			ns
	DCLK↑ - SDI	t <sub>H0</sub>		6	-	-	ns
Hold Time	DCLK↑ - LE	t <sub>H1</sub>		8	-	-	ns
	GCLK – LE ↑ (Vsync)	t <sub>H2</sub>		300			ns
	DCLK – SDO	t <sub>PD0</sub>		-	22	25	ns
Propagation Delay Time	GCLK – OUT2n *	t <sub>PD1</sub>	V <sub>DD</sub> =5.0V V <sub>IH</sub> =V <sub>DD</sub>	-	35	-	ns
Time	LE – SDO	t <sub>PD2</sub> ***	V <sub>IL</sub> =GND	-	30	40	ns
Staggered Delay of Output	OUT2n+1 **	t <sub>DL1</sub>	R <sub>ext</sub> =1.4KΩ V <sub>DS</sub> =1V R <sub>I</sub> =300Ω	-	5	-	ns
Pulse Width	LE	t <sub>w(LE)</sub>	C_=10pF	15			ns
Command to Commar	nd	Tcc	C <sub>1</sub> =100nF C <sub>2</sub> =10µF	50	-	-	ns
Data Clock Frequency	1	F <sub>DCLK</sub>	C <sub>SDO</sub> =10pF	-	-	30	MHz
Gray Scale Clock Free	quency***	F <sub>GCLK</sub>	$V_{LED}$ =4.0V	-	-	33	MHz
GCLK frequency ( when GCLK multiplie	er is enabled )	F <sub>GCLK</sub>				16.6	MHz
Min Clock(GCLK/DCL	,	t <sub>W(CLK)</sub>		12	-	-	ns
Ratio of (GCLK freq)/(	DCLK freq)	R <sub>(GCLK/DCLK)</sub>		20	-	-	%
Compulsory Error Dete time*****	ection Operation	t <sub>ERR-C</sub>		700	-	-	ns
Output Rise Time of C	output Ports	t <sub>or</sub>		-	15	25	ns
Output Fall Time of Ou	utput Ports	t <sub>OF</sub>		-	15	25	ns
Dead Time		t <sub>dth</sub>		300			ns
Dead Time ( Low state	9)	t <sub>dtl</sub>		1200	-	-	ns

\*Output waveforms have good uniformity among channels.

\*\* Refer to the Timing Waveform, where n=0, 1, 2, 3, 4, 5, 6, 7.

\*\*\*In timing of "configuration read", the next DCLK rising edge should be  $t_{PD2}$  after LE's falling edge.

\*\*\*\*The Gray Scale Clock period must be 50% duty cycle when the function of GCLK multiplier is enabled.

\*\*\*\*\*Users have to leave more time than the maximum error detection time for the error detection.

for 1:32 Time-multiplexing Applica	tions							
Switching Characteristics ( $V_{DD}$ =3.3V, Ta=25°C)								

Characteristics		Symbol	Condition	Min.	Тур.	Max.	Unit
	SDI - DCLK ↑	t <sub>suo</sub>		7	-	-	ns
	LE – DCLK ↑	t <sub>su1</sub>		10	-	-	ns
Setup Time	$LE\downarrow(Vsync)-GCLK$	t <sub>SU2</sub>		1200	-	-	ns
	$LE\downarrow -DCLK\uparrow$	t <sub>su3</sub>		52			ns
	DCLK↑ - SDI	t <sub>H0</sub>		8	-	-	ns
Hold Time	DCLK↑ - LE	t <sub>H1</sub>		10	-	-	ns
	$GCLK-LE\downarrow(Vsync)$	t <sub>H2</sub>		300	-	-	ns
	DCLK – SDO	t <sub>PD0</sub>		-	25	30	ns
Propagation Delay Time	GCLK –OUT2n*	t <sub>PD1</sub>	V <sub>DD</sub> =3.3V V <sub>IH</sub> =V <sub>DD</sub>	-	45	-	ns
TIME	LE – SDO	t <sub>PD2</sub> ***	V <sub>IL</sub> =GND		40	50	ns
Staggered Delay of Output			R <sub>ext</sub> =1.4KΩ V <sub>DS</sub> =1V	-	8	-	ns
Pulse Width	LE	t <sub>w(LE)</sub>	R <sub>L</sub> =300Ω C <sub>L</sub> =10pF	16			ns
Command to Commar	าป	tcc	C <sub>1</sub> =100nF C <sub>2</sub> =10µF	52	-	-	ns
Data Clock Frequency	1	F <sub>DCLK</sub>	C <sub>SDO</sub> =10pF	-	-	25	MHz
Gray Scale Clock Free		F <sub>GCLK</sub>	$V_{LED}$ =4.0V	-	-	20	MHz
GCLK frequency ( when GCLK multiplie	er is enabled )	F <sub>GCLK</sub>				10	MHz
Min Clock(GCLK/DCL		t <sub>W(CLK)</sub>		13			ns
Ratio of (GCLK freq)/(	DCLK freq)	R <sub>(GCLK/DCLK)</sub>		20		-	%
Compulsory Error Detetime*****	ection Operation	t <sub>ERR-C</sub>		700	-	-	ns
Output Rise Time of C	output Ports	t <sub>or</sub>			25	35	ns
Output Fall Time of Ou	utput Ports	t <sub>OF</sub>			25	35	ns
Dead Time		tdth		300	-	-	ns
Dead Time ( Low state	e)	tdtl		1200	-	_	ns

\*Output waveforms have good uniformity among channels.

\*\* Refer to the Timing Waveform, where n=0, 1, 2, 3, 4, 5, 6, 7.

\*\*\*In timing of "configuration read", the next DCLK rising edge should be t<sub>PD2</sub> after LE's falling edge.

\*\*\*\*The Gray Scale Clock period must be 50% duty cycle when the function of GCLK multiplier is enabled.

\*\*\*\*\*Users have to leave more time than the maximum error detection time for the error detection.

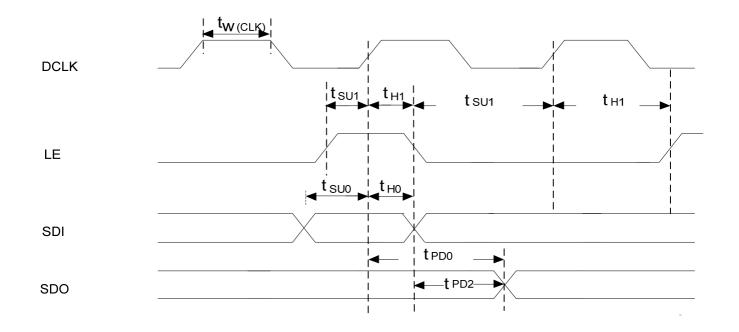
V<sub>IL</sub> = 0 V

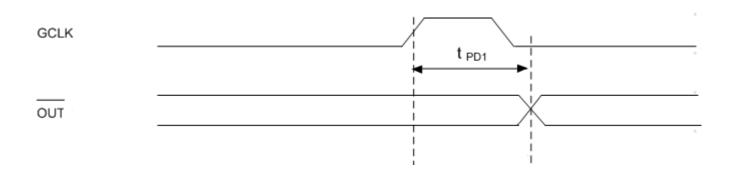
....

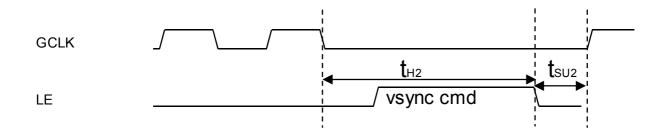
#### for 1:32 Time-multiplexing Applications **Test Circuit for Switching Characteristics** IDD V<sub>DD</sub> ∔c₁ lout VDD $V_{IH}$ , $V_{IL}$ SDI DCLK Function Generator LE OUT15 GCLK SDO R-EXT GND V<sub>LED</sub> → C<sub>2</sub> Rext S $V_{IH} = VDD$ $\mathbf{C}_{\text{SDO}}$

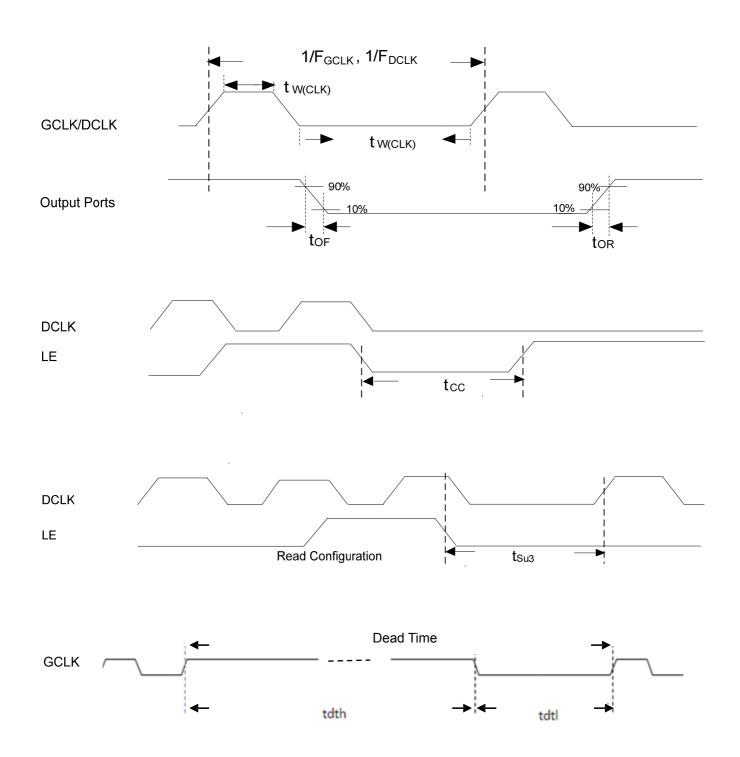
Figure 3

#### Timing Waveform









### for 1:32 Time-multiplexing Applications

#### **Control Command**

	Sign	als Combination	Description					
Command Name	LE	Number of DCLK Rising Edge when LE is asserted	Action of Command					
Stop Compulsory Error detection High 1		1	Stop compulsory LED open detection.					
Data Latch	High	1	Serial data are transferred to the input data buffers.					
VSYNC	High	2	Vertical Synchronal signal. Displaying frame will be updated to output channel.					
Write Configuration 1* High 4		4	Serial data are written to the configuration register.1					
Read Configuration 1	High	5	Serial data are read from the configuration register.1					
Start Compulsory Error detection	High	7	Start compulsory LED open detection					
Write Configuration 2*	High	8	Serial data are written to the configuration register.2					
Read Configuration 2	High	9	Serial data are read from the configuration register.2					
Software Reset High 10		10	Reset the behavior of MBI5153 except the value of configuration registers.					
Pre-Active High 14		14	Pre-Active command needs to be sent before "Write Configuration" command.					

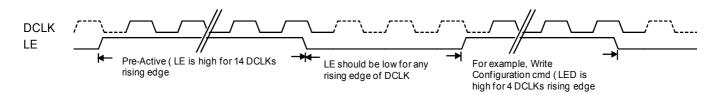
\*Those commands can only be activated after Pre-Active command; otherwise, they will be invalid. **Note:** When the power is on, Vsync command will be valid only after 16 times of "Data Latch" commands that have been sent in advance.

The following figures show the waveforms of commands which require or don't require "Pre-Active" ahead.

#### Commands which don't require Pre-Active ahead

DCLK LE \_Commands which ₩ don't require Pre-Active ahead. Vsync cmd is one of the examples. (LE is high for 2DCLKs rising edge)

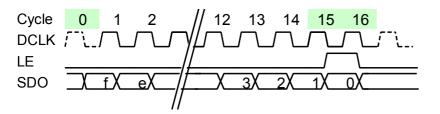
#### **Commands which require Pre-Active ahead**



#### Waveform of Commands

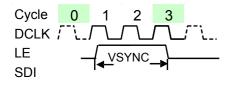
The following figures show the waveforms of each command.

#### Data Latch



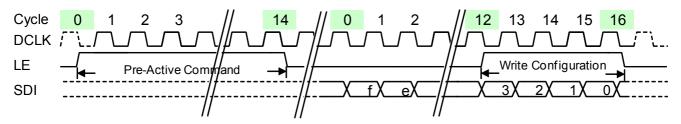
Data Latch command is used to latch the 16-bit shift register from SDI to internal SRAM buffer. When this command is received, the last 16 bits data before the falling edge of LE will be latched into SRAM, as shown in the above waveform, and MSB bit needs to be sent first.

#### Vertical Sync (VSYNC)



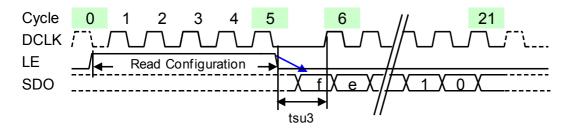
"VSYNC" command is used to update frame data on output channels (OUTC~OUT15). There are some timing limitations between signal "LE" and "GCLK"; and please refer to the section of "Vsync Command Operation" for details.

#### Write Configuration



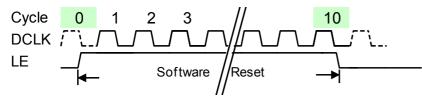
"Write configuration" command is used to program the configuration register of MBI5153. The "Pre-Active" command must be sent in advance. When this command is received, the last 16 bits data before the falling edge of LE will be latched into configuration register, as shown in the above waveform, and MSB bit needs to be sent first.

#### **Read Configuration**



"Read configuration" command is used to read the configuration register of MBI5153. When this command is received, the 16-bit data of configuration register will be shifted out from SDO pin, as shown in the above waveform, and MSB bit will be shifted out first.

#### **Software Reset**



"Software reset" command makes MBI5153 go back to the initial state except configuration register value. After this command is received, the output channels will be turned off and will display again with last gray-scale value after new "Vsync" command is received.

### **Definition of Configuration Register 1**

MSB															LSB
F	E	D	С	В	Α	9	8	7	6	5	4	3	2	1	0

e.g. Default Value

F	E	D	С	В	Α	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	1	1	0	0			101	011		

Default setting of configuration register is 16'h032B

Bit	Attribute	Definition	Value	Function
F	Read/Write	Lower ghost	0 (Default)	0:Disable
Г	Read/white	elimination	0 (Delault)	1:Enabled
E~D	Reserved	Reserved	00 (Default)	Reserved
				00000: 1 line
			00000	00001: 2 lines
	B-8 Read/Write	Number of each	00001	00010: 3 lines
B-8		Number of scan lines	00010 00011 (Default)	00011: 4 lines
			~	
			11111	11110: 31 lines
				11111: 32 lines
				The 16384 GCLKs (14-bit) PWM cycle is
			0 (Default)	divided into 32 sections, and each section
7	Read/Write	Gray scale mode		has 512 GCLKs.
	inedu/ winte		1	The 8192 GCLKs(13-bit) PWM cycle is divided into 16 sections, and each section has 512 GCLKs.,
6	Read/Write	CCI K multiplior	0 (Default)	GCLK multiplier disable
0	Read/white	GCLK multiplier	1	GCLK multiplier enable
		Current goin		6'b101011 (Default)
5~0	Read/Write	Current gain	000000~111111	Allow 64-step programmable current gain
		adjustment		from 12.5 % to 200%

### **Definition of Configuration Register 2**

F E D C B A 9 8 7 6 5 4 3 2 1 0	MSB													LSB
		D	С	Α	9	8	7	6	5	4	3	2	1	0

e.g. Default Value

- 3															
F	E	D	С	В	Α	9	8	7	6	5	4	3	2	1	0
0	0	0	1	0	0	0	0	0	0	0	1	0	0	0	0

Default setting of configuration register is 16'h032B

Bit	Attribute	Definition	Value	Function
F~B	Reserved	Reserved	Reserved	Reserved
^	Dood/M/rito	Double	0/Defeuilt)	0: Disable
A	Read/Write	refresh rate	0(Default)	1: Enable
9~4	Reserved	Reserved	Reserved	Reserved
3~1	Read/Write	dim line compensation	000 (Default)	000: 0 ns, 100: 20ns 001: 5 ns, 101: 25ns 010: 10 ns, 110: 30ns 011: 15 ns, 111: 35ns
0	Reserved	Reserved	Reserved	Reserved

#### Number of Scan Line

MBI5153 supports 1 to 32 scan lines. Please set the configuration register1 bit [C:8] according to the application. The default value '00011' is 4 scan lines.

#### Gray Scale Mode and Scan-type S-PWM

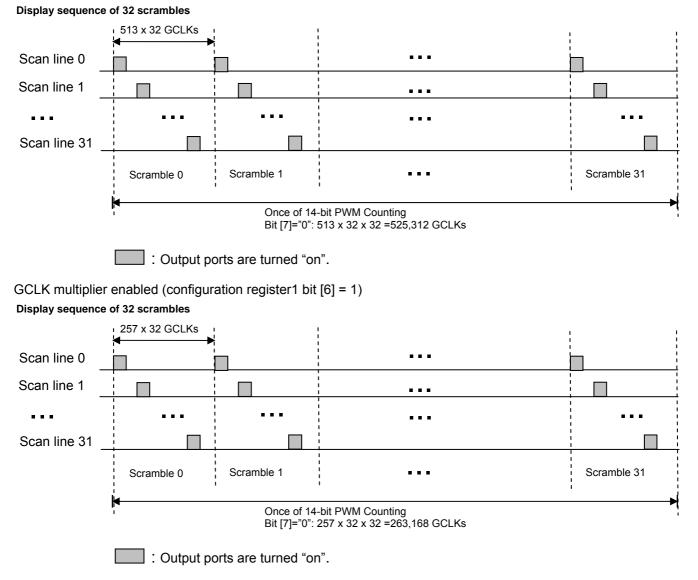
MBI5153 provides a selectable 14-bit or 13-bit gray scale by setting the configuration register1 bit [7]. The default value is set to '0' for 14-bit color depth. In 14-bit gray scale mode, users should still send 16-bit data with 2-bit '0' in LSB bits. For example, {14'h1234, 2'h0}.

MBI5153 has a smart S-PWM technology for scan type. With S-PWM, the total PWM cycles can be broken into MSB (Most Significant Bits) and LSB (Least Significant Bits) of gray scale cycles. The MSB information can be broken down into many refresh cycles to achieve overall same high bit resolution.

#### **GCLK** multiplier

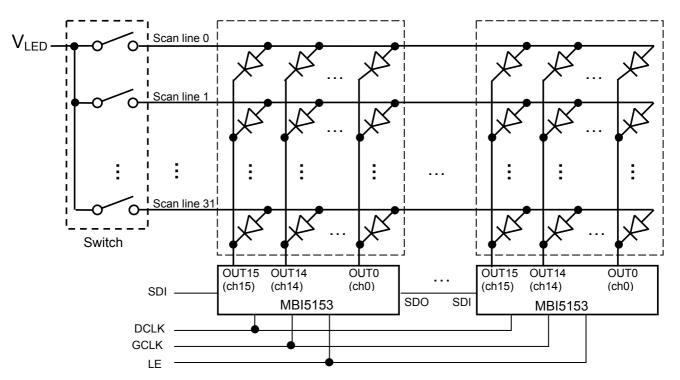
MBI5153 provides a GCLK multiplier function by setting the configuration register1 bit [6]. The default value is set to '0' for GCLK multiplier disable.

#### GCLK multiplier disabled (configuration register1 bit [6] = 0)



#### **Operation Principal**

#### Scan type application structure



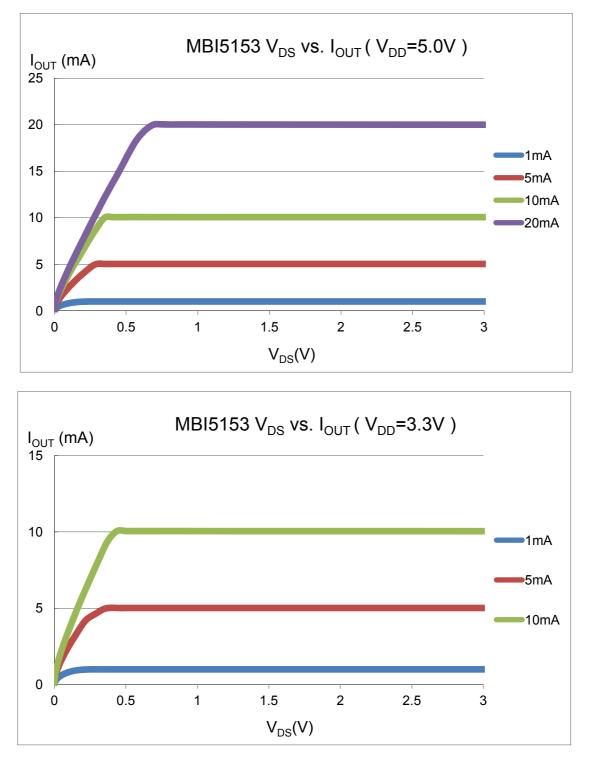
The above figure shows the suggested application structure of scan type scheme with 32 scan lines. The gray-scale data are sent by pin "SDI and SDO" with the commands formed by pin "LE" and "DCLK". The output ports from 16 channels ( $\overline{OUT0} \sim \overline{OUT15}$ ) will output the PWM result for each scan line at different time, so there must be one "Switch" to multiplex for each scan line. The switching sequence and method and the command usage will be described in the application note.

#### **Constant Current**

In LED display application, MBI5153 provides nearly no variation in current from channel to channel and from IC to IC. This can be achieved by:

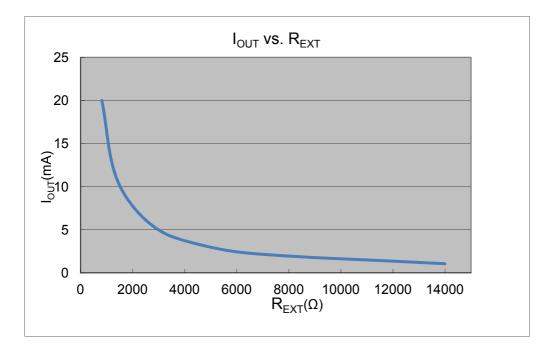
1) The maximuml current variation between channels is less than 2.5%, and that between ICs is less than  $\pm 3\%$ 

2) In addition, the current characteristic of output stage is flat and user can refer to the figure below. The output current can be kept constant regardless of the variations of LED forward voltages ( $V_F$ ). This guarantees LED to be performed on the same brightness as user's specification.



#### **Setting Output Current**

The output current ( $I_{OUT}$ ) is set by an external resistor,  $R_{ext}$ . The default relationship between  $I_{OUT}$  and  $R_{ext}$  is shown in the following figure.

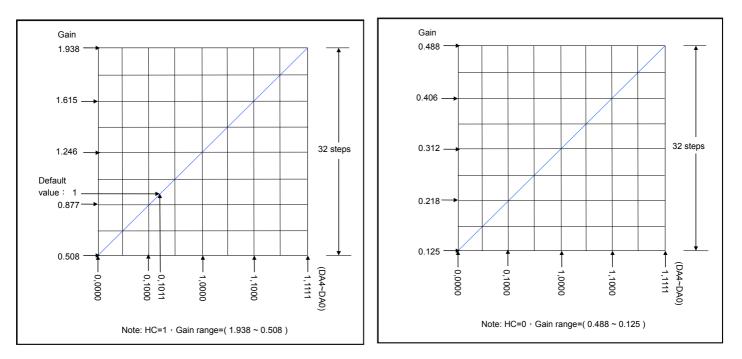


Also, the output current can be calculated from the equation:

V<sub>R-EXT</sub>=0.61Volt x G; I<sub>OUT</sub>= (V<sub>R-EXT</sub>/R<sub>ext</sub>) x24.0

Whereas  $R_{ext}$  is the resistance of the external resistor connected to R-EXT terminal and  $V_{R-EXT}$  is its voltage. G is the digital current gain, which is set by the bit5 – bit0 of the configuration register. The default value of G is 1. The formula and setting for G are described in next section.

#### **Current Gain Adjustment**



The 6 bits (bit 5~bit 0) of the configuration register set the gain of output current, i.e., G. As total 6-bit in number, i.e., ranging from 6'b000000 to 6'b111111, these bits allow user to set the output current gain up to 64 levels. These bits can be further defined inside configuration register as follows:

F	Е	D	С	В	А	9	8	7	6	5	4	3	2	1	0
-	-	-	-	-	-	-	-	-	-	HC	DA4	DA3	DA2	DA1	DA0

1. Bit 5 is HC bit. The setting is in low current band when HC=0, and in high current band when HC=1.

2. Bit 4 to bit 0 are DA4 ~ DA0.

The relationship between these bits and current gain G is:

HC=1, D=(65xG-33)/3

HC=0, D=(256xG-32)/3

and D in the above decimal numeration can be converted to its equivalent in binary form by the following equation: D=  $DA4x2^4+DA3x2^3+DA2x2^2+DA1x2^1+DA0x2^0$ 

In other words, these bits can be looked as a floating number with 1-bit exponent HC and 5-bit mantissa DA4~DA0. For example,

HC=1, G=1.246, D=(65x1.246-33)/3=16

the D in binary form would be:

 $D=16=1x2^{4}+0x2^{3}+0x2^{2}+0x2^{1}+0x2^{0}$ 

The 6 bits (bit 5~bit 0) of the configuration register are set to 6'b110000.

#### Package Power Dissipation (PD)

The maximum allowable package power dissipation is determined as  $P_D(max)=(Tj-Ta)/R_{th(j-a)}$ . When 16 output channels are turned on simultaneously, the actual package power dissipation is

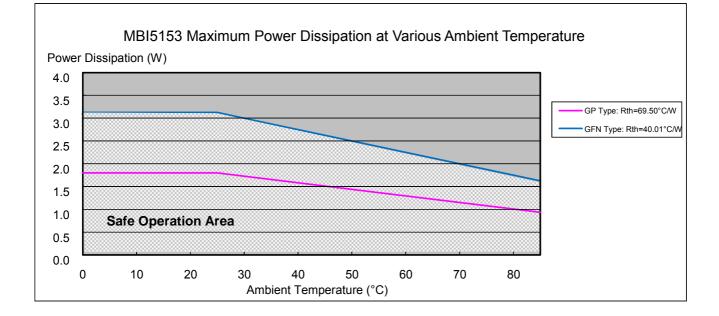
 $P_D(act)=(I_{DD}xV_{DD})+(I_{OUT}xDutyxV_{DS}x16)$ . Therefore, to keep  $P_D(act) \le P_D(max)$ , the allowable maximum output current as a function of duty cycle is:

 $I_{\text{OUT}}=\{[(Tj-Ta)/R_{th(j-a)}]-(I_{\text{DD}}xV_{\text{DD}})\}/V_{\text{DS}}/Duty/16, \text{ where } Tj=150^{\circ}\text{C}.$ 

Please see the follow table for  $\mathsf{P}_{\mathsf{D}}$  and  $\mathsf{R}_{th(j\text{-}a)}$  for different packages:

Device Type	R <sub>th(j-a)</sub> (°C/W)	P <sub>D</sub> (W)
GP	69.50	1.79
GFN	40.01	3.12

The maximum power dissipation,  $P_D(max)=(Tj-Ta)/R_{th(j-a)}$ , decreases as the ambient temperature increases.

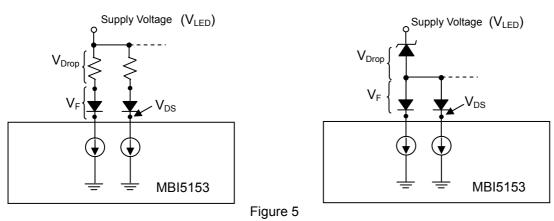


#### LED Supply Voltage (V<sub>LED</sub>)

MBI5153 is designed to operate with V<sub>DS</sub> ranging from 0.4V to 1.0V (depending on I<sub>OUT</sub>=1~20mA) considering the package power dissipating limits. V<sub>DS</sub> may be higher enough to make  $P_{D (act)} > P_{D (max)}$  when V<sub>LED</sub>=5V and V<sub>DS</sub>=V<sub>LED</sub>-V<sub>F</sub>, in which V<sub>LED</sub> is the load supply voltage. In this case, it is recommended to use the lowest possible supply voltage or to set an external voltage reducer, V<sub>DROP</sub>.

A voltage reducer lets  $V_{DS}=(V_{LED}-V_F)-V_{DROP}$ .

Resistors or Zener diode can be used in the applications as shown in the following figures.

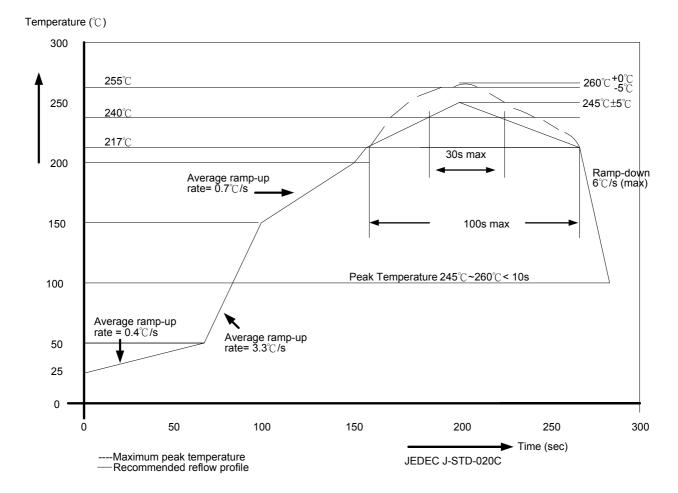


#### **Switching Noise Reduction**

LED drivers are frequently used in switch-mode applications which always behave with switching noise due to the parasitic inductance on PCB. To eliminate switching noise, refer to "Application Note for 8-bit and 16-bit LED Drivers- Overshoot".

### for 1:32 Time-multiplexing Applications Soldering Process of "Pb-free & Green" Package Plating\*

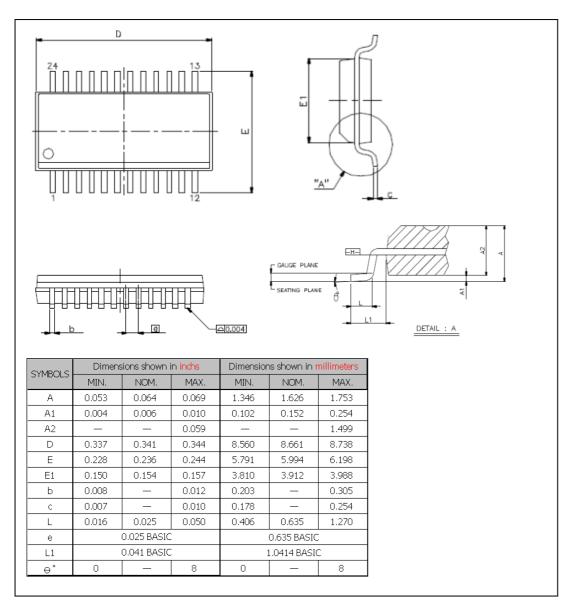
Macroblock has defined "Pb-Free & Green" to mean semiconductor products that are compatible with the current RoHS requirements and selected 100% pure tin (Sn) to provide forward and backward compatibility with both the current industry-standard SnPb-based soldering processes and higher-temperature Pb-free processes. Pure tin is widely accepted by customers and suppliers of electronic devices in Europe, Asia and the US as the lead-free surface finish of choice to replace tin-lead. Also, it adopts tin/lead (SnPb) solder paste, and please refer to the JEDEC J-STD-020C for the temperature of solder bath. However, in the whole Pb-free soldering processes and materials, 100% pure tin (Sn) will all require from 245 °C to 260°C for proper soldering on boards, referring to JEDEC J-STD-020C as shown below.



Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> 350-2000	Volume $mm^3 \ge 2000$
<1.6mm	260 +0 °C	260 +0 °C	260 +0 °C
1.6mm – 2.5mm	260 +0 °C	250 +0 °C	245 +0 °C
≧2.5mm	250 +0 °C	245 +0 °C	245 +0 °C

\*Note: For details, please refer to Macroblock's "Policy on Pb-free & Green Package".

#### Package Outline

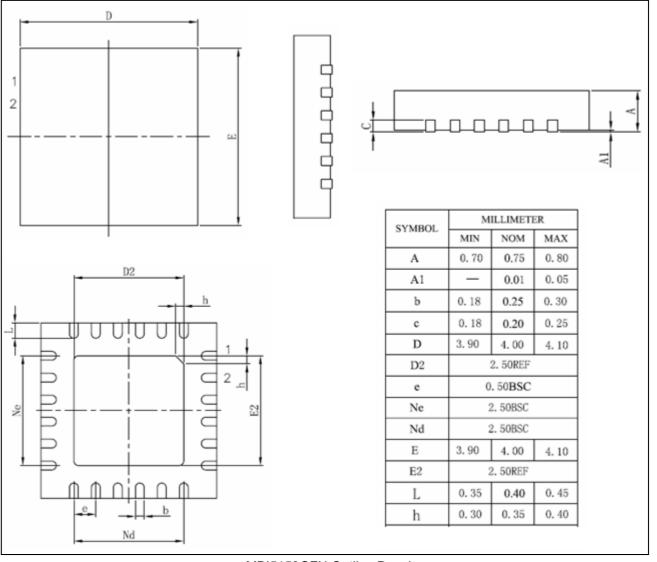


MBI5153 GP Outline Drawing

#### <u>MBI5153</u>

### 16-Channel PWM Constant Current LED Driver

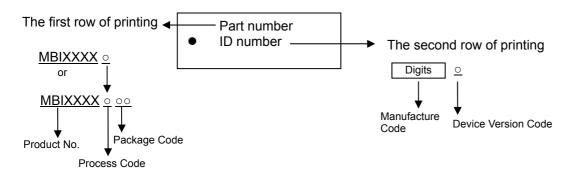
### for 1:32 Time-multiplexing Applications



MBI5153GFN Outline Drawing

Note: The unit of the outline drawing is millimeter (mm).

#### **Product Top Mark Information**



#### **Product Revision History**

Datasheet Version	Devise Version Code
V1.00	A

#### **Product Ordering Information**

Product Ordering Number*	RoHS Compliant Package Type	Weight (g)
MBI5153GP-A	SSOP24L-150-0.64	0.11
MBI5153GFN-A	QFN24L-4*4-0.5	0.0379

\*Please place your order with the "product ordering number" information on your purchase order (PO).

## for 1:32 Time-multiplexing Applications **Disclaimer**

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